

LDBAB3100GC5N0

Aliases (DBAB3100GC5N0)

LDB, Film, Metallized PPS Stacked, General Purpose, 0.1 uF, 2%, 16 VDC, 125°C, 1210, 2mm



Click [here](#) for the 3D model.

Dimensions

| | |
|-----------|-------------------|
| Chip Size | 1210 |
| L | 3.3mm +0.3/-0.1mm |
| W | 2.5mm +/-0.3mm |
| T | 2mm MAX |
| B | 0.4mm +0.5/-0.3mm |

Packaging Specifications

| | |
|--------------------|------|
| Packaging | T&R |
| Packaging Quantity | 2250 |

General Information

| | |
|------------------|------------------------|
| Series | LDB |
| Dielectric | Metallized PPS Stacked |
| Style | SMD Chip |
| RoHS | Yes |
| AEC-Q200 | No |
| Component Weight | 0.089 g |
| Shelf Life | 104 Weeks |
| MSL | 3 |

Specifications

| | |
|-----------------------|------------|
| Capacitance | 0.1 uF |
| Capacitance Tolerance | 2% |
| Voltage DC | 16 VDC |
| Temperature Range | -55/+125°C |
| Rated Temperature | 125°C |
| Dissipation Factor | 0.6% 1kHz |
| Insulation Resistance | 3 GOhms |

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